

CKC21X333JWGAC7210

KC-LINK Auto COG, Ceramic, 0.033 uF, 5%, 650 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 2220



Click here for the 3D model.

Dimensions	
Chip Size	2220
L	6.1mm +/-0.75mm
W	5mm +/-0.4mm
Т	2.5mm +/-0.20mm
В	0.7mm +/-0.35mm

Packaging Specifications	,
Packaging	T&R, 330mm, Plastic Tape
Packaging Quantity	2000

General Information		
Series	KC-LINK Auto COG	
Style	SMD Chip	
Description	SMD, MLCC, FT-CAP, Ultra-Stable	
Features	FT-CAP, Ultra-Stable	
RoHS	Yes	
Termination	Flexible Termination	
Marking	No	
Qualifications	AEC-Q200	
AEC-Q200	Yes	
Component Weight	320 mg	
Shelf Life	78 Weeks	
MSL	1	

Specifications	
Capacitance	0.033 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	5%
Voltage DC	650 VDC
Dielectric Withstanding Voltage	845 VDC
Temperature Range	-55/+150°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	30.303 GOhms

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